



N-Channel Reduced Q_g , Fast Switching MOSFET

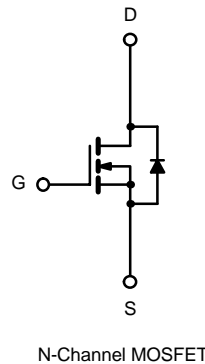
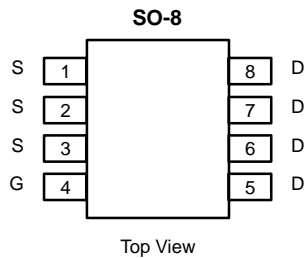
PRODUCT SUMMARY		
V_{DS} (V)	$r_{DS(on)}$ (Ω)	I_D (A)
12	0.0055 @ $V_{GS} = 4.5$ V	17
	0.008 @ $V_{GS} = 2.5$ V	14

FEATURES

- TrenchFET® Power MOSFETS
- PWM Optimized for High Efficiency
- Low Output Voltage
- 100% R_G Tested

APPLICATIONS

- Synchronous Rectifier
- Point-of-Load Synchronous Buck Converter



ABSOLUTE MAXIMUM RATINGS ($T_A = 25^\circ\text{C}$ UNLESS OTHERWISE NOTED)					
Parameter	Symbol	10 secs	Steady State	Unit	
Drain-Source Voltage	V_{DS}	12		V	
Gate-Source Voltage	V_{GS}	± 8			
Continuous Drain Current ($T_J = 150^\circ\text{C}$) ^a	I_D	$T_A = 25^\circ\text{C}$	17	11	A
		$T_A = 70^\circ\text{C}$	14	8	
Pulsed Drain Current	I_{DM}	± 50			
Continuous Source Current (Diode Conduction) ^a	I_S	2.7	1.40		
Maximum Power Dissipation ^a	P_D	$T_A = 25^\circ\text{C}$	3.0	1.6	W
		$T_A = 70^\circ\text{C}$	2.0	1.0	
Operating Junction and Storage Temperature Range	T_J, T_{stg}	-55 to 150		$^\circ\text{C}$	

THERMAL RESISTANCE RATINGS					
Parameter	Symbol	Typical	Maximum	Unit	
Maximum Junction-to-Ambient (MOSFET) ^a	R_{thJA}	$t \leq 10$ sec	34	41	$^\circ\text{C/W}$
		Steady State	67	80	
Maximum Junction-to-Foot (Drain)	R_{thJF}	15	19		

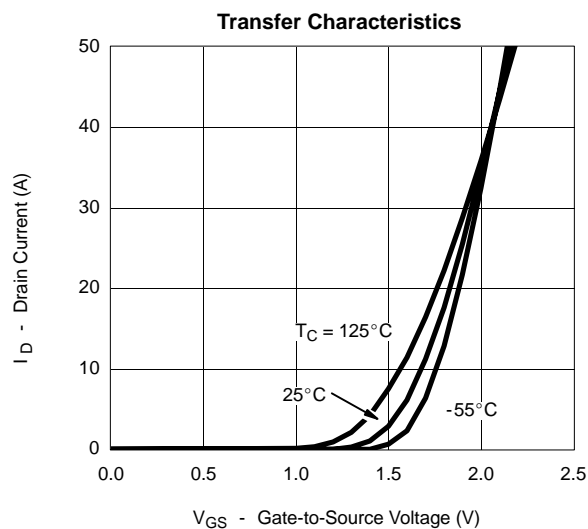
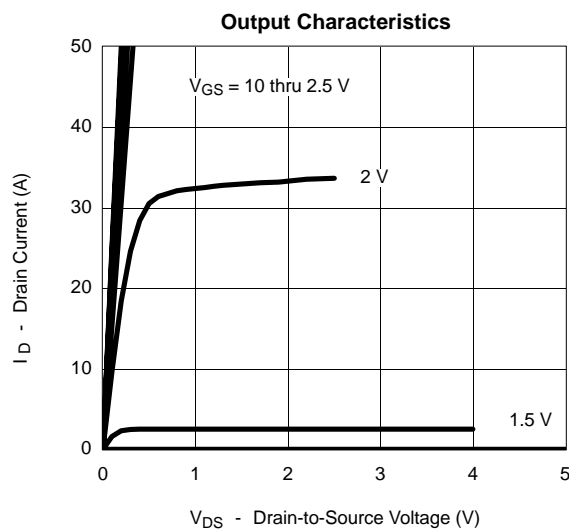
Notes
a. Surface Mounted on 1" x 1" FR4 Board.

MOSFET SPECIFICATIONS ($T_J = 25^\circ\text{C}$ UNLESS OTHERWISE NOTED)

Parameter	Symbol	Test Condition	Min	Typ	Max	Unit
Static						
Gate Threshold Voltage	$V_{GS(th)}$	$V_{DS} = V_{GS}, I_D = 250 \mu\text{A}$	0.6			V
Gate-Body Leakage	I_{GSS}	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 8 \text{ V}$			± 100	nA
Zero Gate Voltage Drain Current	I_{DSS}	$V_{DS} = 9.6 \text{ V}, V_{GS} = 0 \text{ V}$			1	μA
		$V_{DS} = 9.6 \text{ V}, V_{GS} = 0 \text{ V}, T_J = 70^\circ\text{C}$			5	
On-State Drain Current ^a	$I_{D(on)}$	$V_{DS} \geq 5 \text{ V}, V_{GS} = 4.5 \text{ V}$	40			A
Drain-Source On-State Resistance ^a	$r_{DS(on)}$	$V_{GS} = 4.5 \text{ V}, I_D = 17$		0.0045	0.0055	Ω
		$V_{GS} = 2.5 \text{ V}, I_D = 14$		0.0065	0.008	
Forward Transconductance ^a	g_{fs}	$V_{DS} = 6 \text{ V}, I_D = 17$		80		S
Diode Forward Voltage ^a	V_{SD}	$I_S = 2.7 \text{ A}, V_{GS} = 0 \text{ V}$		0.70	1.1	V
Dynamic^b						
Total Gate Charge	Q_g	$V_{DS} = 6 \text{ V}, V_{GS} = 4.5 \text{ V}, I_D = 17 \text{ A}$		21	30	nC
Gate-Source Charge	Q_{gs}		4.6			
Gate-Drain Charge	Q_{gd}		3.5			
Gate Resistance	R_G		1.5	2.3	3.9	Ω
Turn-On Delay Time	$t_{d(on)}$	$V_{DD} = 6 \text{ V}, R_L = 6 \Omega$ $I_D \cong 1 \text{ A}, V_{GEN} = 4.5 \text{ V}, R_G = 6 \Omega$		28	42	ns
Rise Time	t_r		32	48		
Turn-Off Delay Time	$t_{d(off)}$		82	123		
Fall Time	t_f		35	53		
Source-Drain Reverse Recovery Time	t_{rr}	$I_F = 2.7 \text{ A}, di/dt = 100 \text{ A}/\mu\text{s}$		60	90	

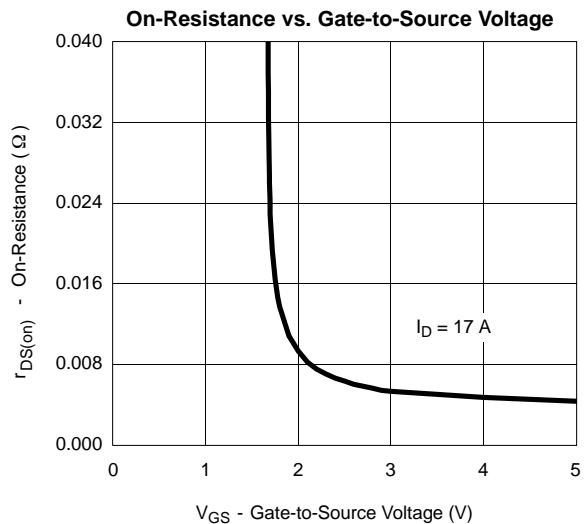
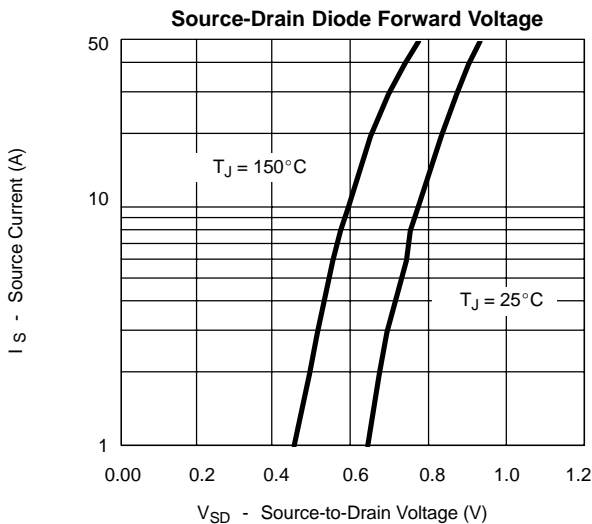
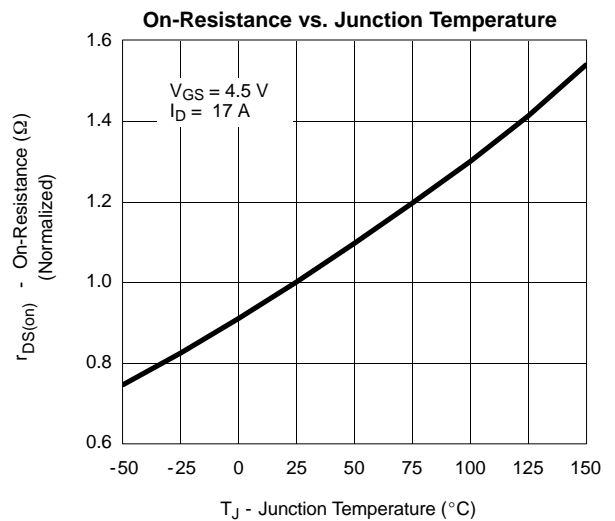
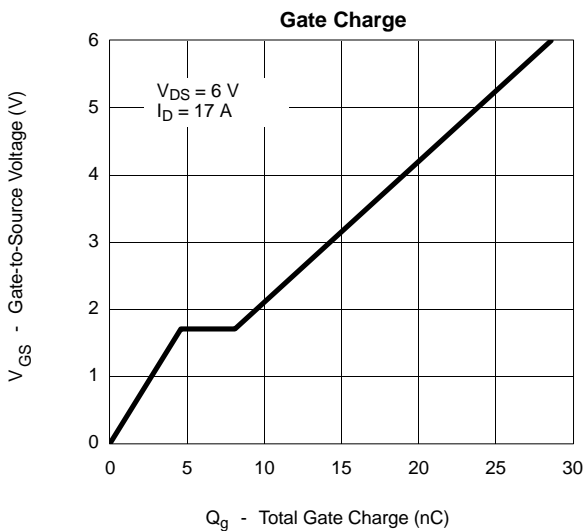
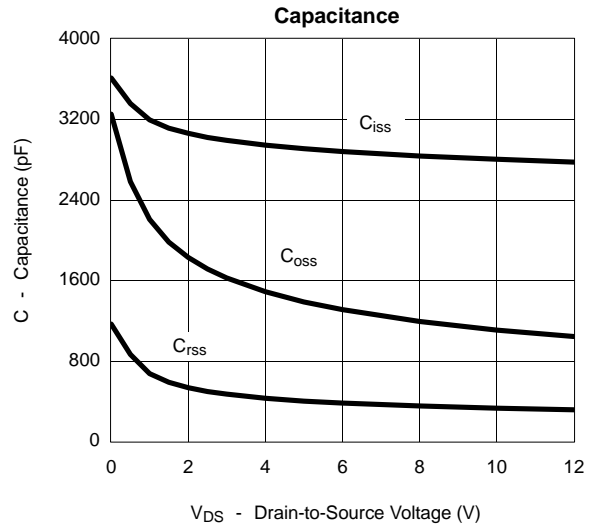
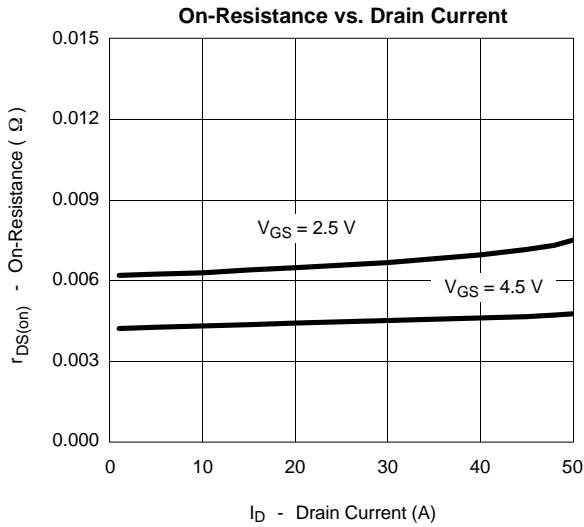
Notes

- a. Pulse test; pulse width $\leq 300 \mu\text{s}$, duty cycle $\leq 2\%$.
b. Guaranteed by design, not subject to production testing.

TYPICAL CHARACTERISTICS (25°C UNLESS NOTED)



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